Fact Sheet

Military Semiconductor Products

THS1206M / 5962-9957701NXD

SGYV084, May 2000

ADC, 12-BIT, 6 MSPS, QUAD CHAN, DSP/µP IF, W/ 16xFIFO, AUTOSCAN, LOW PWR

HIGHLIGHTS / DESCRIPTION

The THS1206M is a CMOS, low-power, 12-bit, 6 MSPS analog-to-digital converter (ADC). The speed, resolution, bandwidth and single-supply operation are suited for applications in radar, imaging, high-speed acquisition and communications. A multistage pipelined architecture with output error correction logic provides for no missing codes over the full operating temperature range. Internal control registers are used to program the ADC into the desired mode. The THS1206M consists of four analog inputs, which are sampled simultaneously. These inputs can be selected individually and configured to single-ended or differential inputs. An integrated 16-word deep FIFO allows the storage of data in order to take the load off of the processor connected to the ADC. Internal reference voltages for the ADC (1.5 V and 3.5 V) are provided.

An external reference can also be chosen to suit the DC accuracy and temperature drift requirements of the application. Two different conversion modes can be selected. In single conversion mode, a single and simultaneous conversion of up to four inputs can be initiated by using the single conversion start signal (CONVST\). The conversion clock in single conversion mode is generated internally using a clock oscillator circuit. In continuous conversion mode, an external clock signal is applied to the CONV_CLK input of the THS1206M. The internal clock oscillator is switched off in continuous conversion mode.

The THS1206M is characterized for operation over the full military temperature range, -55°C to 125°C.

KEY FEATURES/BENEFITS

- High-Speed 6 MSPS ADC
- Simultaneous Sampling of 4 Single-Ended Signals or 2 Differential Input Signals or Combination of Both
- Differential Nonlinearity Error: ±1 LSB
- Integral Nonlinearity Error: ±1.5 LSB
- S-to-N & Distortion Ratio:68dB at fl=2MHz
- Auto-Scan Mode for 2, 3, or 4 Inputs
- 3-V or 5-V Digital Interface Compatible
- Low Power: 216 mW Max
- 5-V Analog Single Supply Operation
- Internal Voltage References
- Glueless DSP Interface
- Parallel uC/DSP Interface
- Integrated FIFO
- Available in TSSOP Package

APPLICATIONS

- Radar / Sonar
- Communications / Control
- High-Speed DSP Front-End

| Parameter Name | TLV1206M |
|--------------------|-------------------------|
| Resolution | 12 Bits |
| Sample Rate | 6 MSPS |
| Supply | 3.0 V to 5.0 V |
| Data-Bus Interface | Parallel |
| Analog Inputs | 4 Channels |
| Power (typ) | 216 mW |
| Vref (Int/Ext) | Internal or External |
| DNL (max) | +/- 1 LSB |
| INL (max) | +/- 1.5 LSB |



TECHNOLOGY

PACKAGING

CMOS, ESD level: 2 KV

Package Option: 32-pin TSSOP QML-Plastic

DIE SIZE

The current die has a size of 87 mils x 169 mils, subject to change.

POWER DISSIPATION

The table below shows modeled data. This data can be used for approximating system thermal characteristics:

Package Thermal Data

| Package | R _θ JA | R _O JC |
|--------------|-------------------|-------------------|
| 32 Pin TSSOP | 86°C/W | 8 °C/W |

*modeled data

Note: Better thermal impedances can be achieved by using air flow, or by increasing metal backplane thickness or trace area in the Printed Circuit Board (PCB).

PROCESS/PERFORMANCE OPTIONS

The THS1206M is processed to the military temperature range at the SNJ-level for programs requiring devices processed to MIL-PRF-38535. The DSCC Standard Microcircuit Drawings (SMD) for these devices are given below.

DSCC SMD

| TI Parent | DSCC SMD # |
|------------|-----------------|
| THS1206MDA | 5962-9957701NXD |

Please Note: This part must be ordered by the DSCC number only.

SUPPORT

You can access data sheets via TI's home page on the internet (http://www.ti.com) or reference the literature number SLAS217D when contacting the PIC.

For additional information on this and other Mixed Signal/Analog Products, visit our Mixed Signal home page at: http://www.ti.com/sc/docs/military/product/mix sig/mixsig 1.htm

Product Information Center

North America

Telephone # - 972-644-5580 (English)

Fax # - 972-480-7800

PIC - www.ti.com/sc/docs/pic/home.htm PIC E-mail - sc-infomaster@ti.com

Military Products -

www.ti.com/sc/docs/military/welcome.htm

Distributor Listing -

www.ti.com/sc/docs/distmenu.htm

Europe

Multilingual Technical Hotline

Francais: +33-(0)1-30 70 11 64
English: +33-(0)1-30 70 11 65
Italiano: 800 79 11 37 (free phone)
Deutsch: +49-(0)8161-80 33 11

E-Mail: epic@ti.com

24 Hours **FAXLINE** +44 (0) 1604 66 33 34



IMPORTANT NOTICE

Texas Instruments Incorporated and its subsidiaries (TI) reserve the right to make corrections, modifications, enhancements, improvements, and other changes to its products and services at any time and to discontinue any product or service without notice. Customers should obtain the latest relevant information before placing orders and should verify that such information is current and complete. All products are sold subject to TI's terms and conditions of sale supplied at the time of order acknowledgment.

TI warrants performance of its hardware products to the specifications applicable at the time of sale in accordance with TI's standard warranty. Testing and other quality control techniques are used to the extent TI deems necessary to support this warranty. Except where mandated by government requirements, testing of all parameters of each product is not necessarily performed.

TI assumes no liability for applications assistance or customer product design. Customers are responsible for their products and applications using TI components. To minimize the risks associated with customer products and applications, customers should provide adequate design and operating safeguards.

TI does not warrant or represent that any license, either express or implied, is granted under any TI patent right, copyright, mask work right, or other TI intellectual property right relating to any combination, machine, or process in which TI products or services are used. Information published by TI regarding third—party products or services does not constitute a license from TI to use such products or services or a warranty or endorsement thereof. Use of such information may require a license from a third party under the patents or other intellectual property of the third party, or a license from TI under the patents or other intellectual property of TI.

Reproduction of information in TI data books or data sheets is permissible only if reproduction is without alteration and is accompanied by all associated warranties, conditions, limitations, and notices. Reproduction of this information with alteration is an unfair and deceptive business practice. TI is not responsible or liable for such altered documentation.

Resale of TI products or services with statements different from or beyond the parameters stated by TI for that product or service voids all express and any implied warranties for the associated TI product or service and is an unfair and deceptive business practice. TI is not responsible or liable for any such statements.

Mailing Address:

Texas Instruments Post Office Box 655303 Dallas, Texas 75265

Copyright © 2002, Texas Instruments Incorporated